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FORM PTO-1595
(Rev. 6-93)
OMB No. 0651-0011 (exp. 4/94)



U.S. Department of Commerce
Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademark,

102241277

by thereof.

1. Name of conveying party(ies):	DATE
Kam S. Law	09/602
Quanyuan Shang	09/602
William R. Harshbarger	09/602
Dan Maydan	092402
Soo Young Choi	091702
Beom Soo Park	091602
Sanjay Yadav	091702
John M. White	091602

2. Name and address of receiving party(ies):
 Name: Applied Materials, Inc.
A Corporation of the State of Delaware

Street Address: 3050 Bowers Ave

Internal Address: M/S 2061

City: Santa Clara State: CA Zip: 95054

Additional name(s) & address(es) attached? Yes No

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: SEE ABOVE

4. Application number(s) or registration number(s): Filed herewith

If this document is being filed together with a new application, the execution date of the application is: 9-24-02 (Date of Filing)

A. Patent Application No.(s) 10/254627

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: APPLIED MATERIALS, INC

Internal Address: PATENT COUNSEL, M/S 2061

Street Address: P.O. Box 450-A

City: Santa Clara State: CA Zip: 95052

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R. 3.41)----- \$ 40.00
 Enclosed

Authorized to be charged to deposit account

50-1074

8. Deposit account number:

50-1074

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

ROBERT W. MULCAHY Reg. No. 25,436

Name of Person Signing

Signature

9-24-02

Date

Total number of pages including cover sheet, attachments and document: 3

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

10/03/2002 6TON11 00000172 501074 10254627

01 FC:581 40.00 CH

PATENT
REEL: 013342 FRAME: 0425

J1036 U.S. PTO
10/254627
09/24/02

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names of Inventors:

1)	Kam S. Law	2)	Quanyuan Shang
3)	William R. Harshbarger	4)	Dan Maydan
5)	Soo Young Choi	6)	Beom Soo Park
7)	Sanjay Yadav	8)	John M. White

(hereinafter referred to as Assignors), have invented a certain invention entitled:

DEPOSITION OF FILM LAYERS

for which application for Letters Patent in the United States is being filed herewith, and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into

any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

- 1) 9/16, 2002 Kam S. Law
Kam S. Law
- 2) 9/16, 2002 Quanyuan Shang
Quanyuan Shang
- 3) 9/16, 2002 William R. Harshbarger
William R. Harshbarger
- 4) 9/24, 2002 Dan Maydan
Dan Maydan
- 5) 9/17, 2002 Seo Young Choi
Seo Young Choi
- 6) 9/16, 2002 Beom Soo Park
Beom Soo Park
- 7) 9/17/02, 2002 Sanjay Yadav
Sanjay Yadav
- 8) 9/16/02, 2002 John M. White
John M. White